



RE969-01

- Adapter TSOP56
- Epoxy fibre-glass 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au
- Solder stop mask
- Adaption circuit board for TSOP56 with 0.635 mm pitch
- Hole spacing 2.54 mm
- Hole diameter 1.10 mm with solder pads Ø 2.10 mm
- Shield pad & cooling field
- Size 39.37 x 41.91 mm